

METHODS FOR PLANARIZATION OF GROUP VIII METAL-CONTAINING
SURFACES USING OXIDIZING GASES

Abstract of the Disclosure

A planarization method includes providing a second and/or third
Group VIII metal-containing surface (preferably, a platinum-containing surface)
and positioning it for contact with a polishing surface in the presence of a
planarization composition that includes an oxidizing gas.

"EXPRESS MAIL" MAILING LABEL NUMBER EL8827056845

DATE OF DEPOSIT: 21 December 2001
I HEREBY CERTIFY THAT THIS PAPER OR FEE IS BEING DEPOSITED WITH THE
UNITED STATES POSTAL SERVICE "EXPRESS MAIL POST OFFICE TO ADDRESSEE"
SERVICE UNDER 37 CFR 1.10 ON THE DATE INDICATED ABOVE AND IS ADDRESSED TO
THE ASSISTANT COMMISSIONER FOR PATENTS. BOX PATENT APPLICATION,
WASHINGTON, D.C. 20231

PRINTED NAME JACQUELYN K. TORBORG

SIGNATURE Jacquelyn K. Torborg